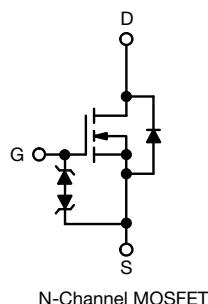


E Series Power MOSFET



RoHS
COMPLIANT
HALOGEN
FREE

FEATURES

- Low figure-of-merit (FOM) $R_{on} \times Q_g$
- Low effective capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Integrated Zener diode ESD protection
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy

PRODUCT SUMMARY	
V_{DS} (V) at T_J max.	850
$R_{DS(on)}$ typ. (Ω) at 25 °C	$V_{GS} = 10$ V 1.17
Q_g max. (nC)	16.5
Q_{gs} (nC)	3
Q_{gd} (nC)	6
Configuration	Single

ORDERING INFORMATION	
Package	DPAK (TO-252)
Lead (Pb)-free and halogen-free	SiHD5N80AE-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	800	V
Gate-source voltage		V_{GS}	± 30	
Continuous drain current ($T_J = 150$ °C)	V_{GS} at 10 V	$T_C = 25$ °C	4.4	A
		$T_C = 100$ °C	2.8	
Pulsed drain current ^a		I_{DM}	7	
Linear derating factor			0.5	W/°C
Single pulse avalanche energy ^b		E_{AS}	17	mJ
Maximum power dissipation		P_D	62.5	W
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +150	°C
Drain-source voltage slope	$T_J = 125$ °C	dv/dt	70	V/ns
Reverse diode dv/dt ^d			0.3	
Soldering recommendations (peak temperature) ^c	For 10 s		260	°C

Notes

- Repetitive rating; pulse width limited by maximum junction temperature
- $V_{DD} = 140$ V, starting $T_J = 25$ °C, $L = 28.2$ mH, $R_g = 25$ Ω, $I_{AS} = 1.1$ A
- 1.6 mm from case
- $I_{SD} \leq I_D$, $di/dt = 100$ A/μs, starting $T_J = 25$ °C

THERMAL RESISTANCE RATINGS

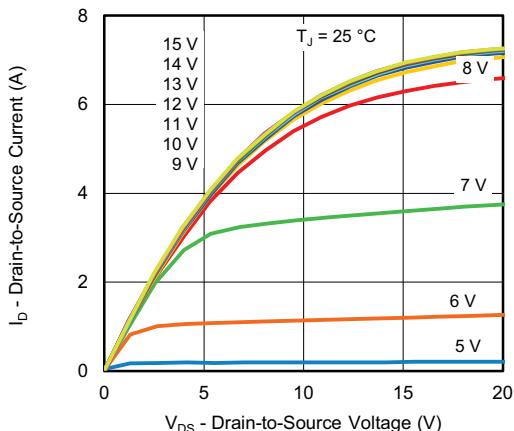
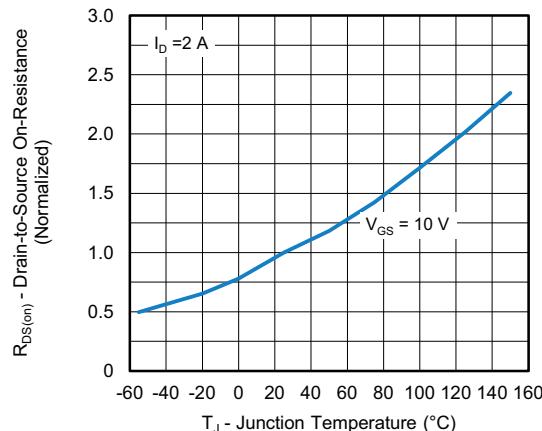
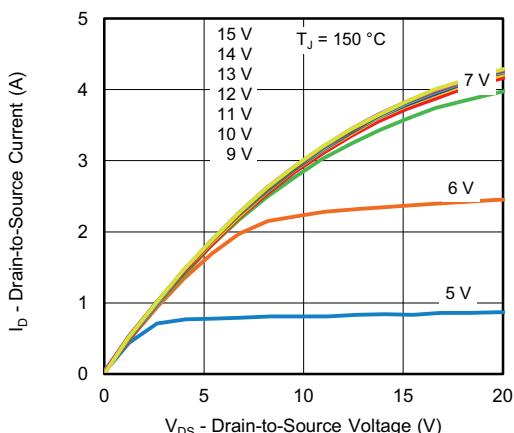
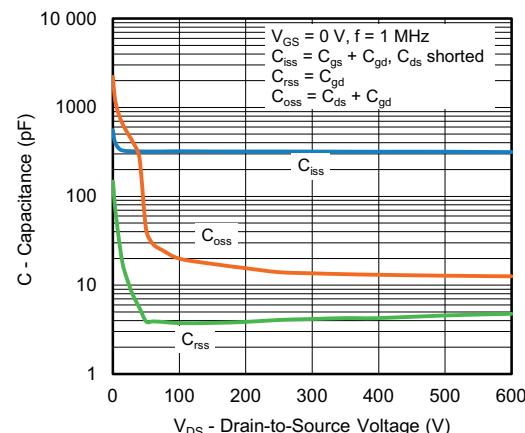
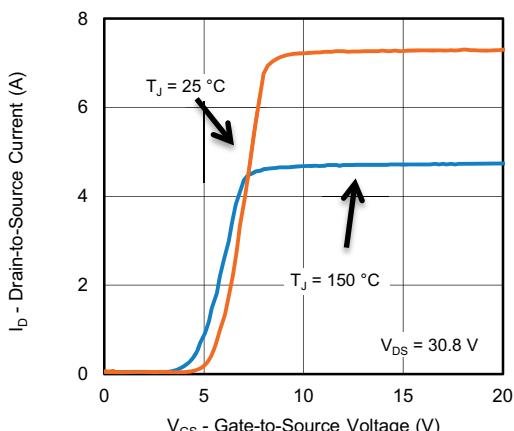
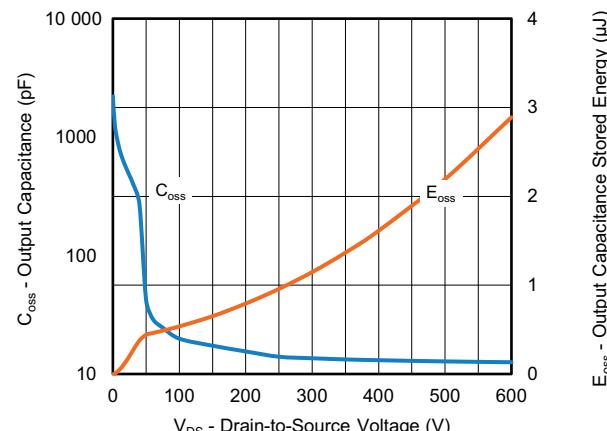
PARAMETER	SYMBOL	MAX.	UNIT
Maximum junction-to-ambient	R_{thJA}	62	
Maximum junction-to-case (drain)	R_{thJC}	2	°C/W

SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0$ V, $I_D = 250$ μ A		800	-	-	V
V_{DS} temperature coefficient	$\Delta V_{DS}/T_J$	Reference to 25 °C, $I_D = 1$ mA		-	0.8	-	V/°C
Gate-source threshold voltage (N)	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250$ μ A		2	-	4	V
Gate-source leakage	I_{GSS}	$V_{GS} = \pm 20$ V		-	-	± 10	μ A
		$V_{GS} = \pm 30$ V		-	-	± 50	
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 800$ V, $V_{GS} = 0$ V		-	-	1	μ A
		$V_{DS} = 640$ V, $V_{GS} = 0$ V, $T_J = 125$ °C		-	-	10	
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS} = 10$ V	$I_D = 1.5$ A	-	1.17	1.35	Ω
Forward transconductance ^a	g_{fs}	$V_{DS} = 30$ V, $I_D = 2$ A		-	1.2	-	S
Dynamic							
Input capacitance	C_{iss}	$V_{GS} = 0$ V, $V_{DS} = 100$ V, $f = 1$ MHz		-	321	-	pF
Output capacitance	C_{oss}			-	20	-	
Reverse transfer capacitance	C_{rss}			-	4	-	
Effective output capacitance, energy related ^a	$C_{o(er)}$	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	14	-	
Effective output capacitance, time related ^b	$C_{o(tr)}$			-	71	-	
Total gate charge	Q_g	$V_{GS} = 10$ V	$I_D = 2$ A, $V_{DS} = 640$ V	-	11	16.5	nC
Gate-source charge	Q_{gs}			-	3	-	
Gate-drain charge	Q_{gd}			-	6	-	
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 640$ V, $I_D = 2$ A, $V_{GS} = 10$ V, $R_g = 9.1$ Ω		-	12	24	ns
Rise time	t_r			-	8	16	
Turn-off delay time	$t_{d(off)}$			-	10	20	
Fall time	t_f			-	28	56	
Gate input resistance	R_g	$f = 1$ MHz, open drain		1.6	3.2	6.4	Ω
Drain-Source Body Diode Characteristics							
Continuous source-drain diode current	I_S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	4.4	A
Pulsed diode forward current	I_{SM}			-	-	7	
Diode forward voltage	V_{SD}	$T_J = 25$ °C, $I_S = 2$ A, $V_{GS} = 0$ V		-	-	1.2	V
Reverse recovery time	t_{rr}	$T_J = 25$ °C, $I_F = I_S = 2$ A, $di/dt = 100$ A/ μ s, $V_R = 25$ V		-	267	534	ns
Reverse recovery charge	Q_{rr}			-	1.2	2.4	μ C
Reverse recovery current	I_{RRM}			-	7.5	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}
b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 1 - Typical Output Characteristics

Fig. 4 - Normalized On-Resistance vs. Temperature

Fig. 2 - Typical Output Characteristics

Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

Fig. 3 - Typical Transfer Characteristics

Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

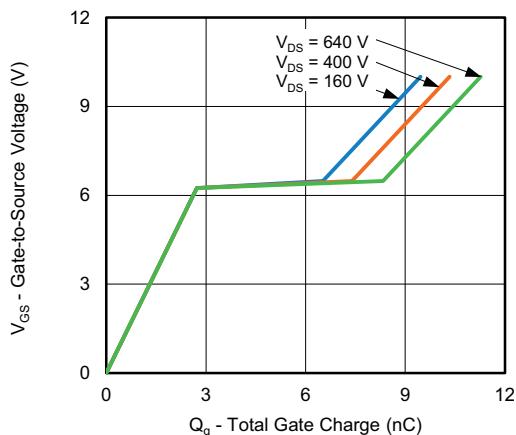


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

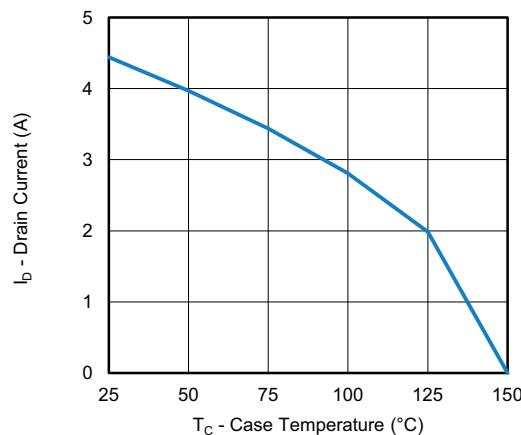


Fig. 10 - Maximum Drain Current vs. Case Temperature

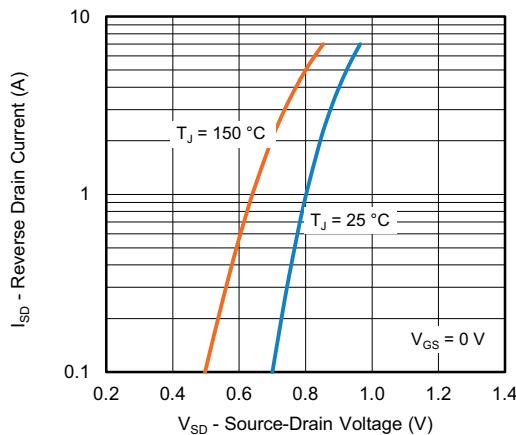


Fig. 8 - Typical Source-Drain Diode Forward Voltage

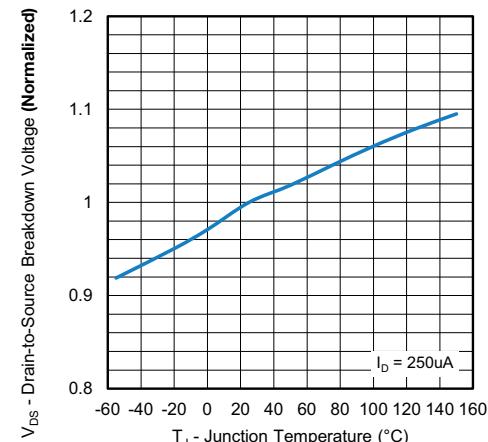


Fig. 11 - Normalized Breakdown Voltage vs. Temperature

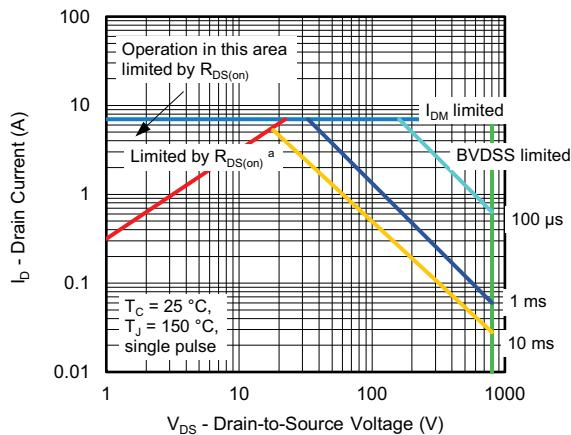


Fig. 9 - Maximum Safe Operating Area

Note

a. $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

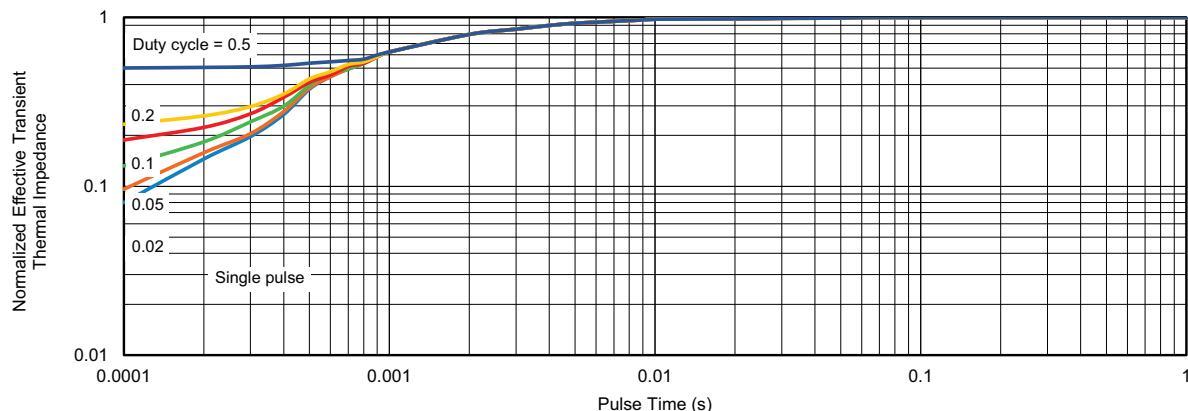


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

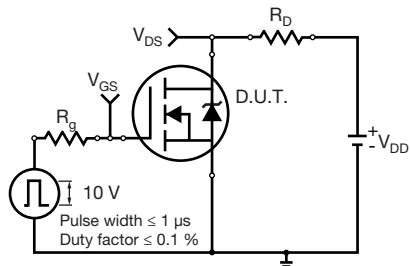


Fig. 13 - Switching Time Test Circuit

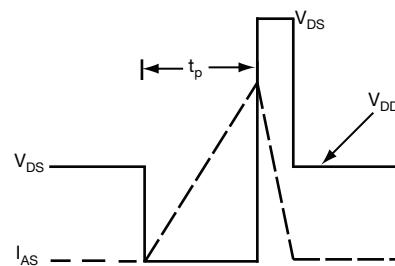


Fig. 16 - Unclamped Inductive Waveforms

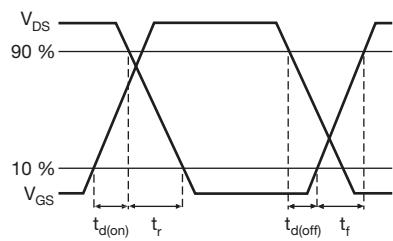


Fig. 14 - Switching Time Waveforms

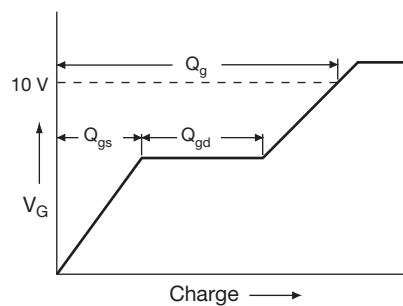


Fig. 17 - Basic Gate Charge Waveform

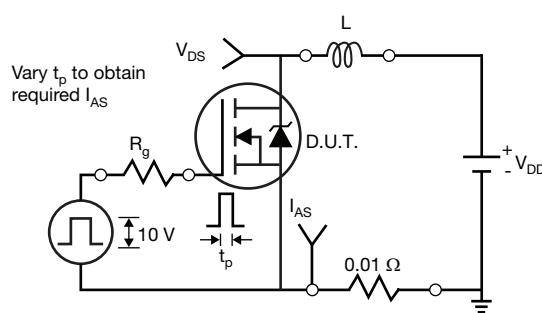


Fig. 15 - Unclamped Inductive Test Circuit

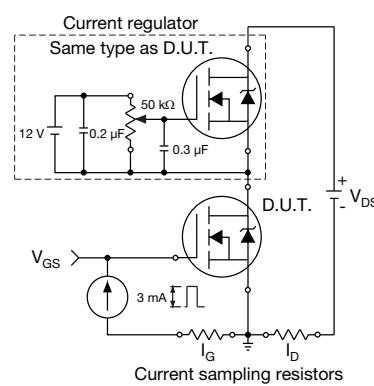


Fig. 18 - Gate Charge Test Circuit

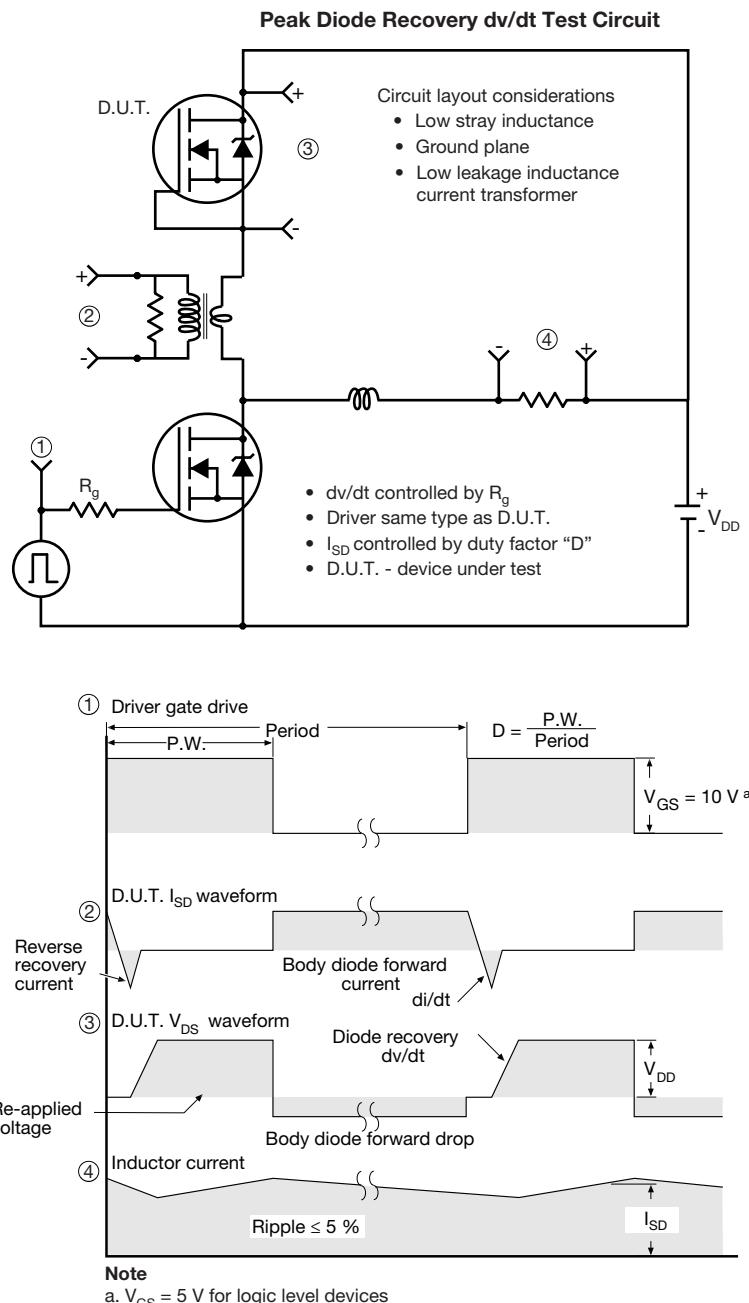
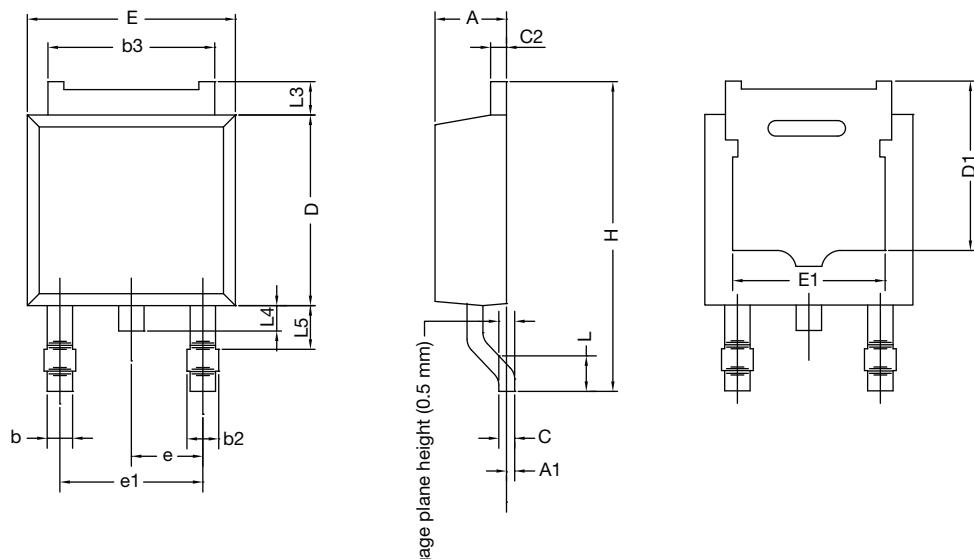


Fig. 19 - For N-Channel

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TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y

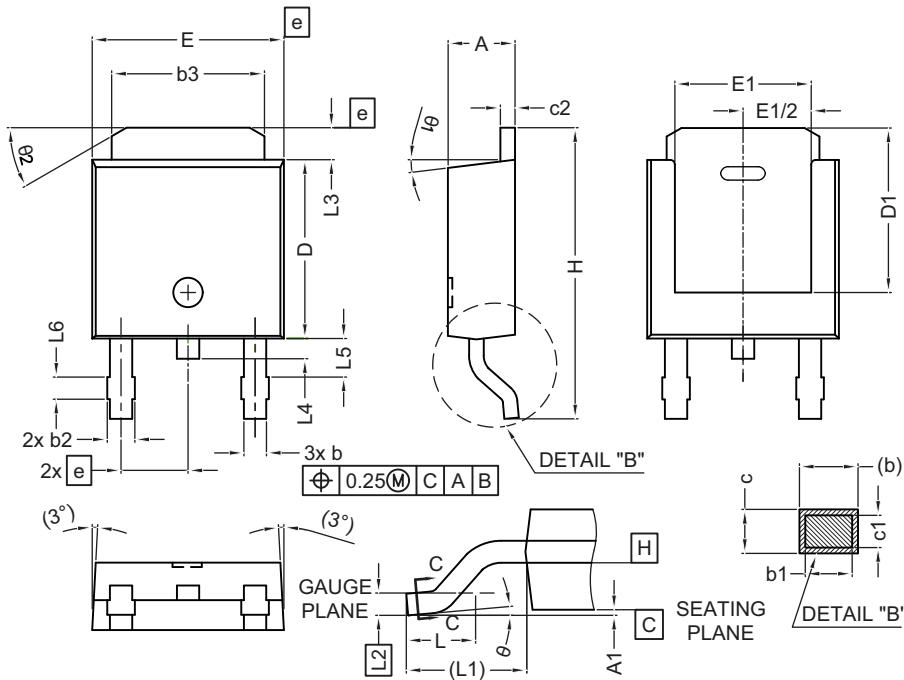


MILLIMETERS		
DIM.	MIN.	MAX.
A	2.18	2.38
A1	-	0.127
b	0.64	0.88
b2	0.76	1.14
b3	4.95	5.46
C	0.46	0.61
C2	0.46	0.89
D	5.97	6.22
D1	4.10	-
E	6.35	6.73
E1	4.32	-
H	9.40	10.41
e	2.28 BSC	
e1	4.56 BSC	
L	1.40	1.78
L3	0.89	1.27
L4	-	1.02
L5	1.01	1.52

Note

- Dimension L3 is for reference only

VERSION 2: FACILITY CODE = N



MILLIMETERS		
DIM.	MIN.	MAX.
A	2.18	2.39
A1	-	0.13
b	0.65	0.89
b1	0.64	0.79
b2	0.76	1.13
b3	4.95	5.46
c	0.46	0.61
c1	0.41	0.56
c2	0.46	0.60
D	5.97	6.22
D1	5.21	-
E	6.35	6.73
E1	4.32	-
e	2.29 BSC	
H	9.94	10.34

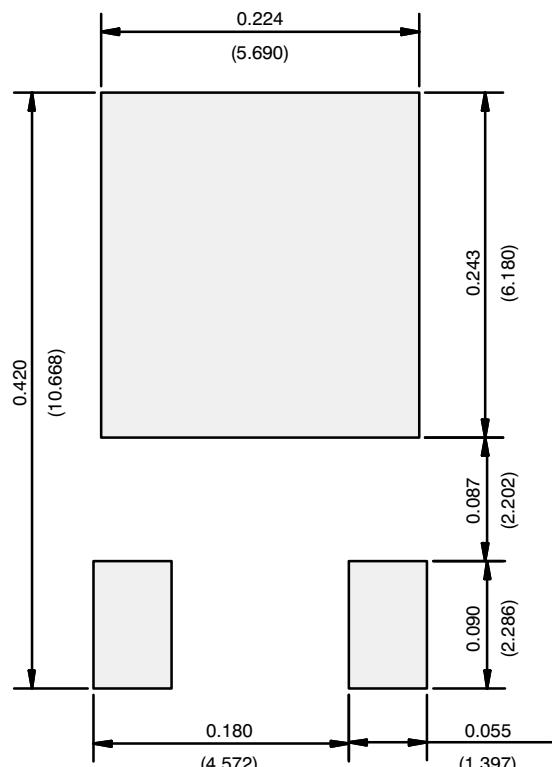
MILLIMETERS		
DIM.	MIN.	MAX.
L	1.50	1.78
L1	2.74 ref.	
L2	0.51 BSC	
L3	0.89	1.27
L4	-	1.02
L5	1.14	1.49
L6	0.65	0.85
θ	0°	10°
θ1	0°	15°
θ2	25°	35°

Notes

- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022
 DWG: 5347

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



**Recommended Minimum Pads
Dimensions in Inches/(mm)**

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